## **Ordering Information**

Part Number	Package	Packing
HV7350K6-G	56-Lead (8x8) QFN	250/ Tray
HV7350K6-G M937	56-Lead (8x8) QFN	2000/Reel

<sup>-</sup>G denotes a lead (Pb)-free / RoHS compliant package

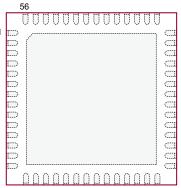
# **Absolute Maximum Ratings**

Parameter	Value
VSUB, substrate voltage is GND	0V
V <sub>LL</sub> , Positive logic supply	-0.5V to +5.5V
$V_{\scriptscriptstyle DD}$ , Positive logic and level translator supply	-0.5V to +5.5V
C <sub>POS</sub> to GND, Positive level translator circuit	-0.5V to +5.5V
C <sub>NEG</sub> to GND, Negative level translator circuit	+0.5V to -5.5V
(V <sub>PP</sub> - C <sub>PF</sub> ), Positive gate driver circuit	-0.5V to +5.5V
$(C_{NF} - V_{NN})$ , Negative gate driver circuit	-0.5V to +5.5V
$(V_{PP} - V_{NN})$ Differential high voltage supply	+130V
V <sub>pp</sub> , High voltage positive supply	-0.5V to +65V
$V_{_{\mathrm{NN}}}$ , High voltage negative supply	+0.5V to -65V
All logic input PIN <sub>x</sub> , NIN <sub>x</sub> , OEN and REN voltages	-0.5V to +5.5V
Operating temperature	-40°C to 125°C
Storage temperature	-65°C to 150°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.



## **Pin Configuration**



56-Lead QFN (top view)

# **Package Marking**



L = Lot Number YY = Year Sealed WW = Week Sealed A = Assembler ID C = Country of Origin . = "Green" Packaging

Package may or may not include the following marks: Si or



#### 56-Lead QFN

# **Typical Thermal Resistance**

<b>7</b> 1	
Package	$oldsymbol{ heta}_{j_{oldsymbol{a}}}$
56-Lead (8x8) QFN	21°C/W

# Output Current & R<sub>on</sub>

I <sub>sc</sub>	$R_{onP}$	$R_{onN}$ $I_{DMP}$		$R_{onDP}$	$R_{\scriptscriptstyle{onDN}}$
1.5A	13Ω	6.5Ω	1.5A	13Ω	00.8

- $1.V_{PP}/V_{NN} = +/-60V, V_{DD} = +3.3V; REN = 1$ 2.  $I_{SC}$  is current into  $1.0\Omega$  to GND;

- 3.  $I_{DMP}$  is current from +/-30V connected to  $T_{x}$  pin.
- 4. Max pulse width for current measurement on  $T_x$  pin is 100ns.

## Power-Up Sequence

Step	Description						
1	V <sub>LL</sub> with logic signal low						
2	$V_{DD}$						
3	REN = 1 (external supplies on)						
4	$V_{_{\mathrm{PP}}}$ and $V_{_{\mathrm{NN}}}$						
5	Logic control signals active						

# **Power-Down Sequence**

Step	Description
1	All logic signals go to low
2	$V_{_{\mathrm{PP}}}$ and $V_{_{\mathrm{NN}}}$
3	REN = 0 (external supplies off)
4	$V_{_{ m DD}}$
5	V <sub>LL</sub>

#### Note:

Powering up/down in any arbitrary sequence will not cause any damage to the device. The powering up/down sequence is only recommended in order to minimize possible inrush current.

# **Operating Supply Voltages and Current (Eight Active Channels)**

(Operating conditions, unless otherwise specified,  $V_{LL}$  = +3.3V,  $V_{DD}$  = +3.3V,  $V_{PP}$  = +60V,  $V_{NN}$  = -60V,  $V_{CLK}$  = +3.3V,  $V_{A}$  = 25°C)

Sym	Parameter	Min	Тур	Max	Units	Conditions
V <sub>DD</sub>	V <sub>DD</sub> voltage supply	2.97	3.30	5.20	V	
UVLO <sub>DD</sub>	V <sub>DD</sub> UVLO	2.30	2.60	2.80	V	
V <sub>LL</sub>	Logic voltage reference	2.50	3.30	5.00	V	
UVLO <sub>LL</sub>	V <sub>LL</sub> UVLO	1.30	1.55	1.70	V	
V <sub>PP</sub>	Positive high voltage supply	+10	-	+60	V	
V <sub>NN</sub>	Negative high voltage supply	-60	-	-10	V	
I <sub>LLQ</sub>	V <sub>LL</sub> current	-	8.0	-		
I <sub>DDQ</sub>	V <sub>DD</sub> current	-	1.0	-		OEN = REN = 0
I <sub>PPQ</sub>	V <sub>PP</sub> current	-	5.0	10	μA	
I <sub>NNQ</sub>	V <sub>NN</sub> current	-	5.0	10		
I <sub>LLEN</sub>	V <sub>LL</sub> current	-	13	20		
I <sub>DDEN</sub>	V <sub>DD</sub> current	-	480	700		OEN = REN = 1
I <sub>PPEN</sub>	V <sub>PP</sub> current	-	220	350	μA	5.0ms after f = 0MHz
I <sub>NNEN</sub>	V <sub>NN</sub> current	-	300	400		
I <sub>DDCW</sub>	V <sub>DD</sub> current	-	2.3	-		f = 5.0MHz, Continuous, no loads,
I <sub>PPCW</sub>	V <sub>PP</sub> current	-	80	-	mA	for calculation reference only.
I <sub>NNCW</sub>	V <sub>NN</sub> current	-	80	-		
I <sub>LL,CLK</sub>	V <sub>LL</sub> current	-	33	-	μA	f <sub>CLK</sub> = 10MHz, PIN = NIN = 0

## **Electrical Characteristics**

(Operating conditions, unless otherwise specified,  $V_{LL}$  = +3.3V,  $V_{DD}$  = +3.3V,  $V_{PP}$  = +60V,  $V_{NN}$  = -60V,  $V_{CLK}$  = +3.3V,  $V_{A}$  = 25°C)

### **Pulser P-Channel MOSFET**

Sym	Parameter	Min	Тур	Max	Units	Conditions
I <sub>OUT</sub>	Output saturation current	1.0	1.5	-	Α	
R <sub>on</sub>	Channel resistance	-	13.2	-	Ω	I <sub>SD</sub> = 100mA

### **Pulser N-Channel MOSFET**

Sym	Parameter	Min	Тур	Max	Units	Conditions
I <sub>OUT</sub>	Output saturation current	1.0	1.5	-	Α	
R <sub>on</sub>	Channel resistance	-	8.0	-	Ω	I <sub>SD</sub> = 100mA

**Damping P-Channel MOSFET** 

Sym	Parameter	Min	Тур	Max	Units	Conditions
I <sub>OUT</sub>	Output saturation current	1.0	1.5	-	Α	
R <sub>on</sub>	Channel resistance	-	13	-	Ω	I <sub>SD</sub> = 100mA

**Damping N-Channel MOSFET** 

Sym	Parameter	Min	Тур	Max	Units	Conditions
I <sub>OUT</sub>	Output saturation current	1.0	1.5	-	Α	
R <sub>on</sub>	Channel resistance	-	9.0	-	Ω	I <sub>SD</sub> = 100mA

**Logic Inputs** 

Sym	Parameter	Min	Тур	Max	Units	Conditions	
V <sub>IH</sub>	Input logic high voltage	0.7 • V <sub>LL</sub>	-	V <sub>LL</sub>	V	V = 2.5 to 2.2V	
V <sub>IL</sub>	Input logic low voltage	0	-	0.3 • V <sub>LL</sub>	V	$V_{LL} = 2.5 \text{ to } 3.3 \text{V}$	
V <sub>IH</sub>	Input logic high voltage	0.8 • V <sub>LL</sub>	-	V <sub>LL</sub>	V	\\ - 5 0\\	
V <sub>IL</sub>	Input logic low voltage	0	-	0.2 • V <sub>LL</sub>	V	$V_{LL} = 5.0V$	
I <sub>IH</sub>	Input logic high current	-	-	10	μΑ		
I	Input logic low current	-10	-	-	μA		
C <sub>IN</sub>	Input logic capacitance	-	-	5.0	pF		

### **MOSFET Drain Bleed Resistor**

Sym	Parameter	Min	Тур	Max	Units	Conditions
R <sub>B1~8</sub>	Output Bleed Resistance	12	17	25	kΩ	
P <sub>RB1~8</sub>	Bleed Resistors Power Limit	-	-	50	mW	

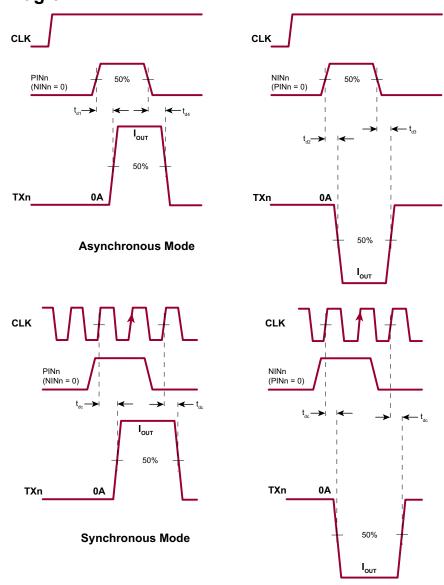
AC Electrical Characteristics (Operating conditions, unless otherwise specified,  $V_{LL}$  = +3.3V,  $V_{DD}$  = +3.3V,  $V_{PP}$  = +60V ,  $V_{NN}$  = -60V,  $V_{CLK}$  = +3.3V,  $V_{A}$  = 25°C)

Sym	Parameter	Min	in Typ Max		Units	Conditions				
t <sub>r</sub>	Output rise time	-	30	-	ns	330pF//2.5kΩ load				
t <sub>f</sub>	Output fall time	-	30	-	ns	10 - 90%				
t <sub>EN</sub>	Enable time	-	300	500	μs	Cap value see page 1 diagram.				
t <sub>DIS</sub>	Disable time	-	2.8	10	μs	OEN = REN				
t <sub>d1</sub>	Delay time on PIN <sub>x</sub> rise	-	12	-						
t <sub>d2</sub>	Delay time on NIN <sub>x</sub> rise	-	12	-		1.0Ω resistor load, D%<1%				
t <sub>d3</sub>	Delay time on damping rise	-	12	-	ns	(See timing diagram) 50% inputs to 50% T <sub>x</sub> current				
t <sub>d4</sub>	Delay time on damping fall	-	12	-		So /s impale to 55 /s T <sub>x</sub> carrent				
t <sub>dc</sub>	Delay time on CLK rise	-	9.0	-						
$\Delta t_{ extsf{DELAY}}$	Delay time matching	-	±3.0	-	ns	P to N, channel to channel				
t <sub>j</sub>	Delay jitter on rise or fall	-	TBD	-	ps	$V_{PP}/V_{NN}$ = +/-25V, input tr 50% to HV <sub>OUT</sub> t <sub>r</sub> or t <sub>r</sub> 50%, with 330pF//2.5kΩ load				
t <sub>rr</sub>	RTZ FETs drain diode t <sub>rr</sub>	-	25	-	ns	$I_F = 1.0A, I_R = 1.0A, R_L = 10\Omega$				
f <sub>CLK</sub>	Re-timing clock frequency	10	220	-	MHz					
$t_{RC}, t_{FC}$	Re-timing clock rise & fall times	-	0.5	5.0	ns					
t <sub>su</sub>	Set-up time, PIN/NIN to CLK	2.0	-	-	ns					
t <sub>H</sub>	Hold time, CLK to PIN/NIN	1.0	-	-	ns					
t <sub>CLK_LO</sub>	Clock time low	2.0	-	100	ns	CLK input must have at least one				
t <sub>CLK_HI</sub>	Clock time high	2.0	-	100	ns	pulse before PIN and NIN inputs are				
t <sub>CLK_REC</sub>	Clock recognition time	-	2.0	-	ns	not zero. Be sure to return inputs to				
t <sub>CLK_RLS</sub>	Clock release time	150	300	800	ns	zero before stopping clock.				
f <sub>out</sub>	Output frequency range	-	-	20	MHz	100Ω resistor load				
HD2	Second harmonic distortion	-	-40	-	dB	10022 TESISIOI IOAU				
C <sub>oss</sub>	Output capacitance	-	50	-	pF	$V_{DS}$ = 25V, f = 1.0MHz , of $T_{X}$ pin total				

## **Truth Table**

	Logic	Inputs		TX <sub>n</sub> Output						
OEN	CLK	PIN <sub>x</sub>	NIN <sub>x</sub>	VPP	VNN	RGND	Note			
1	VLL	0	0	OFF	OFF	ON				
1	VLL	1	0	ON	OFF	OFF	Asynchronous Mode			
1	VLL	0	1	OFF	ON	OFF	Output change on PIN/NIN			
1	VLL	1	1	OFF	FF OFF OFF					
1	<u>_</u>	0	0	OFF	OFF	ON	Synahranaua Mada			
1	<u></u>		0	ON	OFF	OFF	Synchronous Mode Output change at retiming			
1	<u>_</u>	0	1	OFF	ON	OFF	clock(CLK) rising edge,			
1	<u> </u>		OFF	OFF	OFF	registered by PIN/NIN				
0	Х	Х	Х	OFF	OFF	OFF	Disabled			

# **Switching Time Diagram**



# **Pin Description**

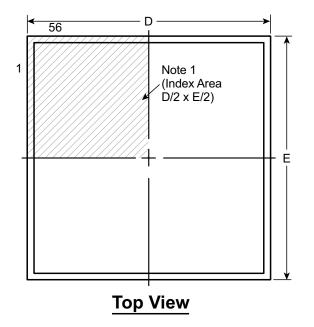
Pin	Name	Description
1	PIN2	Input logic control of high voltage output P-FET for channel 2, Hi = on, Low = off. (see logic table)
2	NIN2	Input logic control of high voltage output N-FET for channel 2, Hi = on, Low = off. (see logic table)
3	PIN3	
		Input logic control of high voltage output P-FET for channel 3, Hi = on, Low = off. (see logic table)
4	NIN3	Input logic control of high voltage output N-FET for channel 3, Hi = on, Low = off. (see logic table)
5	PIN4	Input logic control of high voltage output P-FET for channel 4, Hi = on, Low = off. (see logic table)
6	NIN4	Input logic control of high voltage output N-FET for channel 4, Hi = on, Low = off. (see logic table)
7	OEN	Output enable Hi = on, Low = off. See logic truth table
8	REN	Built-in positive and negative 5V voltage regulators enable. Hi = on, Low = off. If REN = 0, external floating 5V power supplies may be supplied across CPF, CNF CPOS and CNEG capacitors
9	PIN5	Input logic control of high voltage output P-FET for channel 5, Hi = on, Low = off. (see logic table)
10	NIN5	Input logic control of high voltage output N-FET for channel 5, Hi = on, Low = off. (see logic table)
11	PIN6	Input logic control of high voltage output P-FET for channel 6, Hi = on, Low = off. (see logic table)
12	NIN6	Input logic control of high voltage output N-FET for channel 6, Hi = on, Low = off. (see logic table)
13	PIN7	Input logic control of high voltage output P-FET for channel 7, Hi = on, Low = off. (see logic table)
14	NIN7	Input logic control of high voltage output N-FET for channel 7, Hi = on, Low = off. (see logic table)
15	PIN8	Input logic control of high voltage output P-FET for channel 8, Hi = on, Low = off. (see logic table)
16	NIN8	Input logic control of high voltage output N-FET for channel 8, Hi = on, Low = off. (see logic table)
17	VLL	Logic supply voltage and reference input (+3.3V)
18	GND	Logic and circuit return ground (0V)
19	VDD	Positive voltage power supply (+3.3V)
20	VPP	
21	VPP	Positive high voltage power supply (+10 to +60V)
22	VPP	
23	CPF	Built-in linear voltage VPF regulator output decoupling capacitor pin, 1uF from VPP to CPF per each
24	CNF	Built-in linear voltage VNF regulator output decoupling capacitor pin, 1uF from CNF to VNN per each
25	VNN	
26	VNN	Negative high voltage power supply (-10 to -60V)
27	VNN	
28	TX8	T <sub>x</sub> pulser channel 8 output
29	RGND	Damping ground and bleed resistors common return ground
30	TX7	T <sub>x</sub> pulser channel 7 output
31	RGND	Damping ground and bleed resistors common return ground
32	TX6	T <sub>x</sub> pulser channel 6 output

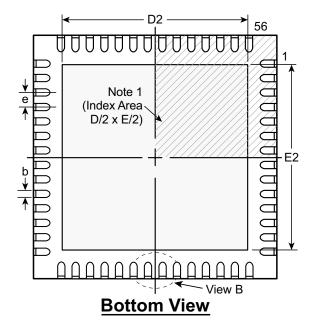
# Pin Description (cont.)

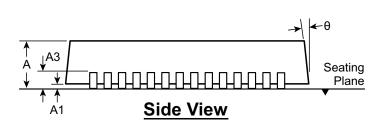
Pin	Name	Description							
33	RGND	Damping ground and bleed resistors common return ground							
34	TX5	T <sub>x</sub> pulser channel 5 output							
35	CNEG	Built-in linear voltage -5V regulator output decoupling capacitor pin, 1.0uF from CNEG to GND							
36	CPOS	Built-in linear voltage +5V regulator output decoupling capacitor pin, 1.0uF from CPOS to GND							
37	TX4	T <sub>x</sub> pulser channel 4 output							
38	RGND	Damping ground and bleed resistors common return ground							
39	TX3	T <sub>x</sub> pulser channel 3 output							
40	RGND	Damping ground and bleed resistors common return ground							
41	TX2	T <sub>x</sub> pulser channel 2 output							
42	RGND	Damping ground and bleed resistors common return ground							
43	TX1	T <sub>x</sub> pulser channel 1 output							
44	VNN								
45	VNN	egative high voltage power supply (-10 to -60V)							
46	VNN								
47	CNF	Built-in linear voltage VNF regulator output decoupling capacitor pin, 1uF from CNF to VNN per each							
48	CPF	Built-in linear voltage VPF regulator output decoupling capacitor pin, 1uF from VPP to CPF per each							
49	VPP								
50	VPP	Positive high voltage power supply (+10 to +60V)							
51	VPP								
52	VDD	Positive voltage power supply (+3.3V)							
53	GND	Logic and circuit return ground (0V)							
54	CLK	Re-timing register clock input. Connect to $V_{\scriptscriptstyle LL}$ to disable the re-timing function							
55	PIN1	Input logic control of high voltage output P-FET for channel 1, Hi = on, Low = off. (see logic table)							
56	NIN1	Input logic control of high voltage output N-FET for channel 1, Hi = on, Low = off. (see logic table)							
VSUB (Thermal Pad)		Substrate bottom is internally connected to the central thermal pad on the bottom of package. It must be connected to GND (0V) externally							

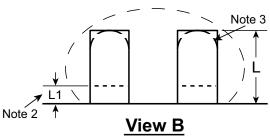
# 56-Lead QFN Package Outline (K6)

# 8.00x8.00mm body, 1.00mm height (max), 0.50mm pitch









#### Notes:

- A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.
- 2. Depending on the method of manufacturing, a maximum of 0.15mm pullback (L1) may be present.
- 3. The inner tip of the lead may be either rounded or square.

Symbol		Α	A1	А3	b	D	D2	E	E2	е	L	L1	θ
Dimension (mm)	MIN	0.80	0.00	0.20 REF	0.18	7.85*	2.75	7.85*	2.75	0.50 BSC	0.30	0.00	<b>0</b> °
	NOM	0.90	0.02		0.25	8.00	5.70	8.00	5.70		0.40	-	-
	MAX	1.00	0.05	IXLI	0.30	8.15*	6.70 <sup>†</sup>	8.15*	6.70 <sup>†</sup>		0.50	0.15	14°

JEDEC Registration MO-220, Variation VLLD-2, Issue K, June 2006.

Drawings are not to scale.

Supertex Doc.#: DSPD-56QFNK68X8P050, Version A031010.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <a href="http://www.supertex.com/packaging.html">http://www.supertex.com/packaging.html</a>.)

**Supertex inc.** does not recommend the use of its products in life support applications, and will not knowingly sell them for use in such applications unless it receives an adequate "product liability indemnification insurance agreement." **Supertex inc.** does not assume responsibility for use of devices described, and limits its liability to the replacement of the devices determined defective due to workmanship. No responsibility is assumed for possible omissions and inaccuracies. Circuitry and specifications are subject to change without notice. For the latest product specifications refer to the **Supertex inc.** (website: http://www.supertex.com)

©2014 **Supertex inc.** All rights reserved. Unauthorized use or reproduction is prohibited.



<sup>\*</sup> This dimension is not specified in the JEDEC drawing.

<sup>†</sup> This dimension differs from the JEDEC drawing.